

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 1511181026 Part Weight 1.146738G

Part Name MGrid ShrdHdr SMT/oPeg&cap 2.5SnLF 26Ckt

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
MGrid ShrdHdr SMT/oPeg∩ 2.5SnLF 26Ckt	Assembly		100	1.146738	
2MM MGrid Hsg DR Shrd Wafer w/o Peg 26ck	Component		60.5195	0.694	
LCP GF BLACK	Material		60.5195	0.694	
Carbon black	Substance	1333-86-4	0.3026	0.00347	
LCP	Substance		41.1533	0.47192	
Further Additives	Substance	system	0.9078	0.01041	
GF-Fibre	Substance		18.1558	0.2082	
0.5mm SqPin Bando w/Swage Brs 2.5SnLF	Assembly		39.4805	0.452738	
0.5mm SqPin Bando w/Swage Brs Unpl	Component		38.3174	0.4394	
Cartridge Brass 70% Unplated	Material		38.3174	0.4394	
Copper	Substance	7440-50-8	26.8222	0.30758	
Zinc (metal)	Substance	7440-66-6	11.4952	0.13182	
Nickel Plating	Material		0.4385	0.005028	

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel	Substance	7440-02-0	0.4385	0.005028
Further Additives	Substance	system	4E-5	5E-7
Tin Plating	Material		0.7246	0.00831
Tin	Substance	7440-31-5	0.7246	0.00831

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision ED/88/2018 (15 January 2019)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold Concentration (PPM) (PPM)		Intentionally Added	
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes	
Lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes	
Nickel	Ep-Ni	*Note	997,500	Yes	

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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	n Intentionally Added	
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes	
Glass fibres	LCP GF BLACK	*Note	300,000	Yes	

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	1511181026							
Part Name	MGrid ShrdHdr SMT/oPeg∩ 2.5SnLF 26Ckt	(e)						
Part Information	on			Haz	zardous S	Substance	s	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
MGrid ShrdH	dr SMT/oPeg∩ 2.5SnLF 26Ckt		0	0	0	0	0	0
2MM MGrid I	Hsg DR Shrd Wafer w/o Peg 26ck		0	0	0	0	0	0
0.5mm SqPir	n Bando w/Swage Brs 2.5SnLF		0	0	0	0	0	0
0.5mm SqPir	n Bando w/Swage Brs Unpl		0	0	0	0	0	0

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Process Information

Component Plating / Surface Finish	MSn-Ni		
Termination Base Alloy	Brass		
Solder Alloy	N/A		
Process Capability	REFLOW		
Maximum Exposure Time (seconds)	010		
Maximum Process Temperature (C)	260		
Maximum Cycles at Reflow Temperature	001		
J-STD-020 Moisture Sensitivity Level	N/A		

Mar 31, 2019